L Number	r Hits	Search Text		
27	7	6225688.URPN.	DB	Time stamp
28	5		USPAT	2003/03/18 12:42
		"5646446"   "5776797").PN.	USPAT	2003/03/18 12:45
31	12	5776797.URPN.		
34	5	("3039177"   "3467892"   "4628408"	USPAT	2003/03/18 12:45
	-	"4833568"   "5289346").PN.	USPAT	2003/03/18 14:09
35	57	5289346.URPN.		*
42	41305	semiconductor and (stacking stacked)	USPAT	2003/03/18 14:09
		semirounductor and (stacking stacked)	USPAT;	2003/03/18 14:37
			US-PGPUB;	
			EPO; JPO;	
43	35232	(semi conductors and )	DERWENT	
	00232	(semiconductor and (stacking stacked)) and (method process)	USPAT;	2003/03/18 14:38
		(method process)	US-PGPUB;	, , , , , , , , , , , , , , , , , , , ,
			EPO; JPO;	1
44	215	( / gominanda )	DERWENT	
	213	((semiconductor and (stacking stacked))	USPAT;	2003/03/18 14:42
		and (method process)) and ((plexible near1	US-PGPUB;	
	1	(tape substrate)) (bonding near tape))	EPO; JPO;	
45	63		DERWENT	
	03	(((semiconductor and (stacking stacked))	USPAT:	2003/03/18 14:40
		and (method process)) and ((nlevible posmi	US-PGPUB;	2003/03/18 14:40
		(cape Substrate)) (bonding near tanally	EPO; JPO;	
46	22	and (bending bended)	DERWENT	
10	23	((plexible near1 (tape substrate))	USPAT;	2003/03/18 14:41
	1	(bonding near tape)) with (bending bended)	US-PGPUB;	2003/03/18 14:41
	1	, J = =================================	EPO; JPO;	
47			DERWENT	
4 /	2	(((semiconductor and (stacking stacked))	USPAT;	2002/02/10 14 44
		and (method process)) and ((nlevible nearl	US-PGPUB;	2003/03/18 14:41
	1	(tape substrate)) (bonding near tanally	EPO; JPO;	
		and (((plexible near) (tape substrato))	DERWENT	
1	1	(DONGING near tape)) with (bending	DEKWENT	
= 0		pended))		
50	248	((semiconductor and (stacking stacked))	USPAT;	0000405455
	1	and (method process)) and ((hlovible		2003/03/18 14:43
		101ded Iolding) near1 (tabe substrate))	US-PGPUB; EPO; JPO;	
-1		(Dollaing near tape))		
51	16	(US-5805422-\$ or US-5394303-\$ or	DERWENT	000040-4
	*   1	US-6225688-\$ or US-5776797-\$ or	USPAT;	2003/03/18 14:43
1	[ ]	US-5646446-\$ or US-6246114-\$ or	US-PGPUB; JPO	
	10	US-5818107-\$ or US-6528353-\$ or	JPO	
	1.0	JS-64/3308-\$ or US-6462412-\$ or		
	1.0	JS-6441476-\$ or US-6300679-\$ or		
	1	JS-6262895-\$ or US-6121676-\$\ did on		
	·   1	(US-20010006252-S).did or		]
		(JP-08222691-\$).did.		]
54	244 (	(((semiconductor and (stacking stacked))	170DD T	1 (
	a	and (method process)) and (((plexible	USPAT;	2003/03/18 14:43
	1 1	Olded Iolding) near; (tane substrate)	US-PGPUB;	
	(	bonding near tape))) not ((US-5805422-\$	EPO; JPO;	
	0	or US-5394303-\$ or US-6225688-\$ or	DERWENT	
	ט	S-5776797-\$ or US-5646446-\$ or		
	ט	S-6246114-\$ or US-5818107-\$ or		
	ט	S-6528353-\$ or US-6473308-\$ or		
1	ט	S-6462412-\$ or US-6441476-\$ or	;	
	0	S-6300679-\$ or US-6262895-\$ or		
İ	l II	S-6121676-\$).did. or		
	1	US-20010006252-\$).did. or		
	1 7.	JP-08222691-\$).did.)		
55	2 (	"6049123"   "6102710").PN.	ļ	
56	0 6	469377.URPN.	USPAT	2003/03/18 14:48
57	0 6	444921.URPN.	USPAT	2003/03/18 14:49
	0 0	IIIJCI.UKIN.	USPAT	2003/03/18 14:55

58		4   44		
30	4	4 ("3795037"   "4271588"   "4547834"	USPAT	2003/03/18 14:55
-	-	"4648179"   "4664309"   "4755417"	001111	2003/03/18 14:55
1		"4783722"   "4800461"   "4858077"		İ
1		"4897918"   "4954877"   "4954878"		
		"5065227"   "5100492"   "5177594"		
		"5199163"   "5264065"   "5306571"		}
1		"5378306"   "5426072"   "5428190"		
1		"5429879"   "5474458"   "5478972"		
		"5483421"   "5499444"   "5530288"		
l		"5544017"   "5573428"   "5575630"		
		"5590460"   "5591519"   "5627405"		
ĺ		"5659153"   "5665650"   "5678287"		
Í		"5682061"   "5688584"   "5691041"		
		"5745986"   "6064576"   "6118671"		
1		"6191952"   "6259037").PN.		
59		6344683.URPN.		· ·
60	7		USPAT	2003/03/18 14:58
		"5815372"   "5933712"   "5995379"	USPAT	2003/03/18 14:58
		"6005292").PN.		
61	10	5933712.URPN.		
62	3		USPAT	2003/03/18 15:00
63	3	("5432729"   "5466634"   "5578516").PN.	USPAT	2003/03/18 15:02
64	5	6121676.URPN.	USPAT	2003/03/18 15:03
65	12	("5008496"   "5229916"   "5345205"	USPAT	2003/03/18 15:08
1		"5783870"   "5790380"   "5805422"	USPAT	2003/03/18 15:09
		"6014316"   "6061245"   "6121676"		
	0.	"6172418"   "6177721"   "6208521").PN.		
66	12	6208521.URPN.		
67	0		USPAT	2003/03/18 15:09
68	12	("5159535"   "5450283"   "5578525"	USPAT	2003/03/18 15:11
		"5646446"   "5773882"   "5783870"	USPAT	2003/03/18 15:11
		"5949142"   "5969426"   "6071755"		
		"5949142"   "5969426"   "6071755"		
71	12	"6075287"   "6208521"   "6324067").PN.		
	1	("5159535"   "5450283"   "5578525"	USPAT	2003/03/18 15:11
		"5646446"   "5773882"   "5783870"   "5949142"   "5969426"   "6071755"		1 20.11
		"5949142"   "5969426"   "6071755"	1	
74	3	"6075287"   "6208521"   "6324067").PN.		
75	17	/"/002532"   "500600"	USPAT	2003/03/18 15:14
=	1 1	("4983533"   "5006925"   "5016138"	USPAT	2003/03/18 15:14
		"5224023"   "5313096"   "5345205"		2000/00/10 10:14
		"5397916"   "5448511"   "5514907"		
		"5602420"   "5604377"   "5648684"		
		"5656856"   "5754405"   "5790390"		
76	00	"6121676" [ "6208521") PN		
79	23	5448511.URPN.	USPAT	2002/02/10 15 15
, ,	4	("3766439"   "5117282"   "5313416"	USPAT	2003/03/18 15:15
80		~3335145").PN.	COLAI	2003/03/18 15:17
81	44	5224023.URPN.	USPAT	2002/02/10 15
82	0	6507106.URPN.	USPAT	2003/03/18 15:19
02	2	("5224023"   "5646446").PN.	USPAT	2003/03/18 15:20
		,	LOSPAT	2003/03/18 15:20